# **ANALOG** Wideband, 40 dB Isolation at 1 GHz, CMOS 1.65 V to 2.75 V SPST Switches 1.65 V to 2.75 V, SPST Switches

#### **FEATURES**

Wideband switch: -3 dB @ 4.5 GHz ADG901—absorptive switch ADG902—reflective switch High off isolation: 40 dB @ 1 GHz Low insertion loss: 0.8 dB @1 GHz Single 1.65 V to 2.75 V power supply **CMOS/LVTTL control logic** 8-lead MSOP and tiny 3 mm  $\times$  3 mm LFCSP packages Low power consumption (<1  $\mu$ A)

#### **APPLICATIONS**

Wireless communications General purpose RF switching **Dual-band applications High speed filter selection Digital transceiver front end switch** IF switching **Tuner modules** Antenna diversity switching list **GENERAL DESCRIPTION** 

The ADG901/ADG902 are wideband switches that use a CMOS process to provide high isolation and low insertion loss to 1 GHz. The ADG901 is an absorptive (matched) switch with 50  $\Omega$  terminated shunt legs, while the ADG902 is a reflective switch. These devices are designed such that the isolation is high over the dc to 1 GHz frequency range. They have on-board CMOS control logic, thus eliminating the need for external controlling circuitry. The control inputs are both CMOS and

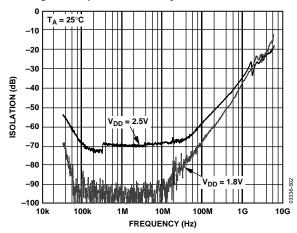


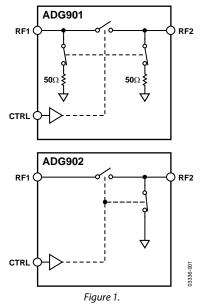
Figure 2. Off Isolation vs. Frequency

#### Rev. B

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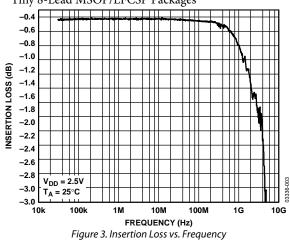
## ADG901/ADG902

#### FUNCTIONAL BLOCK DIAGRAM



LVTTL compatible. The low power consumption of these CMOS devices makes them ideally suited to wireless applications and general-purpose high frequency switching. **PRODUCT HIGHLIGHTS** 

- 1. -40 dB Off Isolation @ 1 GHz
- 0.8 dB Insertion Loss @ 1 GHz 2.
- Tiny 8-Lead MSOP/LFCSP Packages 3.



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### IMPORTANT LINKS for the <u>ADG901\_902</u>\*

Last content update 08/17/2013 12:41 am

PARAMETRIC SELECTION TABLES Choosing the Correct Switch or Multiplexer for Your Application Switches and Multiplexers Product Selection Guide	DESIGN COLLABORATION COMMUNITY engineer zone Support Collaborate Online with the ADI support team and other designe about select ADI products.
<b>DOCUMENTATION</b> AN-952: ADG9xx Wideband CMOS Switches: Frequently Asked Questions	Follow us on Twitter: <u>www.twitter.com/ADL News</u> Like us on Facebook: <u>www.facebook.com/AnalogDevicesInc</u>
Use Circuits from the Lab <sup>™</sup> in Your Next Design	
CMOS Switches Offer High Performance in Low Power, Wideband Applications	DESIGN SUPPORT
Enhanced Multiplexing for MEMS Optical Cross Connects RF Source Booklet	Submit your support request here: Linear and Data Converters Embedded Processing and DSP
<b>EVALUATION KITS &amp; SYMBOLS &amp; FOOTPRINTS</b> View the Evaluation Boards and Kits page for the ADG901 View the Evaluation Boards and Kits page for the ADG902 Symbols and Footprints for the ADG901 Symbols and Footprints for the ADG902	Telephone our Customer Interaction Centers toll free: Americas: 1-800-262-5643 Europe: 00800-266-822-82 China: 4006-100-006 India: 1800-419-0108 Russia: 8-800-555-45-90Quality and Reliability Lead(Pb)-Free Data
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### **SPECIFICATIONS**

 $V_{DD}$  = 1.65 V to 2.75 V, GND = 0 V, input power = 0 dBm, all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise specified.<sup>1</sup>

Table 1.

titions M D bias dc bias 100 MHz; V <sub>DD</sub> = 2.5 V ± 10%		Typ <sup>2</sup>	<b>Max</b> 2.5	<b>Unit</b> GHz
bias dc bias	С		2.5	GH7
bias dc bias	C		2.5	GH7
dc bias				GLIZ
dc bias			4.5	GHz
			7	dBm
100 MHz; $V_{DD} = 2.5 V \pm 10\%$			16	dBm
		0.4	0.7	dB
$Hz; V_{DD} = 2.5 V \pm 10\%$		0.5	0.8	dB
MHz; $V_{DD} = 2.5 V \pm 10\%$		0.8	1.25	dB
IHz 60	0	61		dB
IHz 43	3	45		dB
MHz 34	4	40		dB
IHz 5	1	60		dB
IHz 37	7.5	47		dB
MHz 3 <sup>-</sup>	1	37		dB
100 MHz 20	0	28		dB
IHz 23	3	29		dB
MHz 25	5	28		dB
100 MHz 18	8	23		dB
IHz 17	7	21		dB
MHz 15	5	19		dB
TRL to 90% RF		3.6	6	ns
TRL to 10% RF		5.8	9.5	ns
		3.1	5.5	ns
o 10% RF		6.0	8.5	ns
MHz				dBm
1Hz/901 MHz. 4 dBm 28	8.5	36		dBm
				mV p-j
2 25 V to 2 75 V 1	7			V
				v
			07	v
				v
				•
N ≤ 2.75 V		±0.1	±1	μA
ИНz		1.2		рF
=				pF
	.65		2.75	V
-		0.1		μA
	AHz       4.         MHz       3.         MHz       2.         MHz       2.         MHz       1.         MHz       1.         CTRL to 90% RF       1.         CTRL to 10% RF       1.         CO 10% RF       1.         MHz       1.         MHz       1.         2.25 V to 2.75 V       1.         1.65 V to 1.95 V       0.         2.25 V to 2.75 V       1.         MHz       1.         N $\leq 2.75$ V       1.         MHz       1.         MHz       1.         MHz       1.         MHz       1.         MHz       1. <td>MHz; <math>V_{DD} = 2.5 V \pm 10\%</math>       60         MHz       43         MHz       34         MHz       34         MHz       31         MHz       31.0         MHz       20         MHz       21         MHz       23         MHz       23         MHz       25         MHz       18         MHz       15         CTRL to 90% RF       15         CTRL to 10% RF       28.5         2.25 V to 2.75 V       1.7         1.65 V to 1.95 V       0.65 V_{DD}         2.25 V to 2.75 V       1.7         1.65 V to 1.95 V       .         MHz       1.65 V_{DD}</td> <td>MHz, <math>V_{DD} = 2.5 V \pm 10\%</math>       0.8         MHz       60       61         MHz       43       45         MHz       34       40         MHz       37.5       47         MHz       31       37         100 MHz       20       28         MHz       23       29         MHz       23       29         MHz       18       23         MHz       15       19         CTRL to 90% RF       3.6       3.1         co 10% RF       6.0       3.1         mHz       17       28.5       36         2.25 V to 2.75 V       1.7       0.65 V_{DD         2.25 V to 2.75 V       1.7       0.65 V_{DD         N ≤ 2.75 V       ±0.1       40.1         MHz       1.2       1.2         MHz       2.1       1.65   </td> <td>MHz; <math>V_{DD} = 2.5 V \pm 10\%</math>       0.8       1.25         AHz       60       61         AHZ       43       45         MHZ       34       40         AHZ       51       60         MHZ       31       37         MHZ       20       28         AHZ       23       29         MHZ       23       29         MHZ       18       23         AHZ       17       21         MHZ       15       19         CTRL to 90% RF       3.6       6         CTRL to 10% RF       5.8       9.5         at 000 MHz       15       19         CTRL to 10% RF       6.0       8.5         MHz       17       21         MHZ       28.5       36         at 10% RF       6.0       8.5         MHZ       1.7       0.65 V_{DD}         2.25 V to 2.75 V       1.7       0.35         N <math>\leq 2.75 V</math> <math>\pm 0.1</math> <math>\pm 1</math>         MHz       1.2          N <math>\leq 2.75 V</math> <math>\pm 0.1</math> <math>\pm 1</math>         MHz       1.65       2.75</td>	MHz; $V_{DD} = 2.5 V \pm 10\%$ 60         MHz       43         MHz       34         MHz       34         MHz       31         MHz       31.0         MHz       20         MHz       21         MHz       23         MHz       23         MHz       25         MHz       18         MHz       15         CTRL to 90% RF       15         CTRL to 10% RF       28.5         2.25 V to 2.75 V       1.7         1.65 V to 1.95 V       0.65 V_{DD}         2.25 V to 2.75 V       1.7         1.65 V to 1.95 V       .         MHz       1.65 V_{DD}	MHz, $V_{DD} = 2.5 V \pm 10\%$ 0.8         MHz       60       61         MHz       43       45         MHz       34       40         MHz       37.5       47         MHz       31       37         100 MHz       20       28         MHz       23       29         MHz       23       29         MHz       18       23         MHz       15       19         CTRL to 90% RF       3.6       3.1         co 10% RF       6.0       3.1         mHz       17       28.5       36         2.25 V to 2.75 V       1.7       0.65 V_{DD         2.25 V to 2.75 V       1.7       0.65 V_{DD         N ≤ 2.75 V       ±0.1       40.1         MHz       1.2       1.2         MHz       2.1       1.65	MHz; $V_{DD} = 2.5 V \pm 10\%$ 0.8       1.25         AHz       60       61         AHZ       43       45         MHZ       34       40         AHZ       51       60         MHZ       31       37         MHZ       20       28         AHZ       23       29         MHZ       23       29         MHZ       18       23         AHZ       17       21         MHZ       15       19         CTRL to 90% RF       3.6       6         CTRL to 10% RF       5.8       9.5         at 000 MHz       15       19         CTRL to 10% RF       6.0       8.5         MHz       17       21         MHZ       28.5       36         at 10% RF       6.0       8.5         MHZ       1.7       0.65 V_{DD}         2.25 V to 2.75 V       1.7       0.35         N $\leq 2.75 V$ $\pm 0.1$ $\pm 1$ MHz       1.2          N $\leq 2.75 V$ $\pm 0.1$ $\pm 1$ MHz       1.65       2.75

 $^1$  Temperature range for B version: –40°C to +85°C.  $^2$  Typical values are at  $V_{\text{DD}}$  = 2.5 V and 25°C, unless otherwise specified.

<sup>3</sup> Point at which insertion loss degrades by 1 dB. <sup>4</sup> Guaranteed by design, not subject to production test. <sup>5</sup> The dc transience at the output of any port of the switch when the control voltage is switched from high to low or low to high in a 50 Ω test setup, measured with 1 ns rise time pulses and 500 MHz bandwidth.

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}C$ , unless otherwise specified.

#### Table 2.

Parameter	Rating
V <sub>DD</sub> to GND	–0.5 V to +4 V
Inputs to GND	-0.5 V to V <sub>DD</sub> + 0.3 V <sup>1</sup>
Continuous Current	30 mA
Input Power	18 dBm
Operating Temperature Range	
Industrial (B Version)	-40°C to +85°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C
MSOP Package	
$\theta_{JA}$ Thermal Impedance	206°C/W
LFCSP Package	
$\theta_{JA}$ Thermal Impedance (2-Layer board)	84°C/W
θ <sub>JA</sub> Thermal Impedance (4-Layer board)	48°C/W
Lead Temperature, Soldering (10 sec)	300°C
IR Reflow, Peak Temperature (<20 sec)	235°C
ESD	1 kV
	·

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $^1$  RF1/RF2 off port inputs to ground: –0.5 V to  $V_{\text{DD}}$  – 0.5 V

#### **ESD CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



### **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

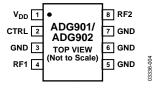


Figure 4. 8-Lead MSOP (RM-8) and 8-Lead 3 mm × 3 mm LFCSP (CP-8 – Exposed pad tied to substrate, GND

#### Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description		
1	V <sub>DD</sub>	Power Supply Input. These parts can be operated from 1.65 V to 2.75 V; V <sub>DD</sub> should be decoupled to GND.		
2	CTRL	MOS or LVTTL Logic Level. CTRL input should not exceed $V_{DD.}$		
		$0 \rightarrow \text{RF1}$ Isolated from RF2.		
		$1 \rightarrow \text{RF1}$ to $\text{RF2}$ .		
3, 5, 6, 7	GND	Ground Reference Point for All Circuitry on the Part.		
4	RF1	RF1 Port.		
8	RF2	RF2 Port.		

#### Table 4. Truth Table

CTRL	Signal Path		
0	RF1 isolated from RF2		
1	RF1 to RF2		

### **TYPICAL PERFORMANCE CHARACTERISTICS**

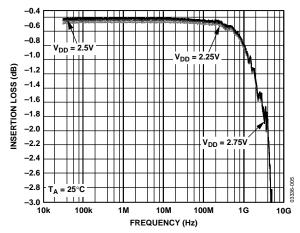


Figure 5. Insertion Loss vs. Frequency over Supplies (S12 and S21)

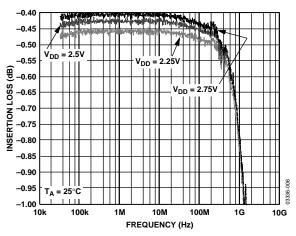


Figure 6. Insertion Loss vs. Frequency over Supplies (S12 and S21) (Zoomed Figure 5 Plot)

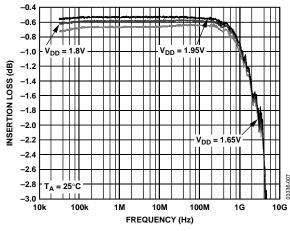


Figure 7. Insertion Loss vs. Frequency over Supplies (S12 and S21)

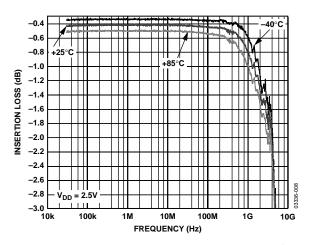


Figure 8. Insertion Loss vs. Frequency over Temperature (S12 and S21)

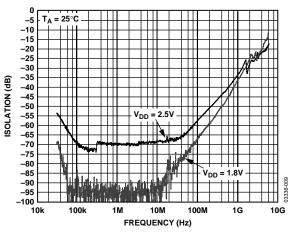


Figure 9. OFF Isolation vs. Frequency over Supplies (S12 and S21)

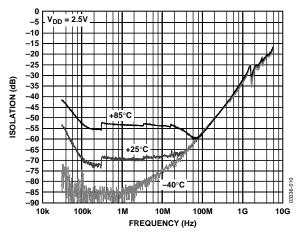


Figure 10. Off Isolation vs. Frequency over Temperature (S12 and S21)

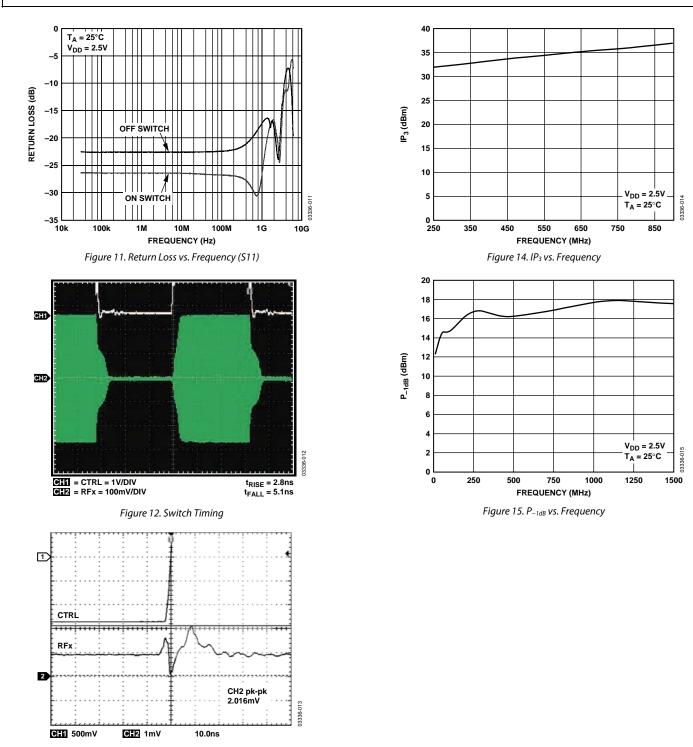


Figure 13. Video Feedthrough

### TERMINOLOGY

 $\mathbf{V}_{\text{DD}}$ Most positive power supply potential.

IDD Positive supply current.

**GND** Ground (0 V) reference.

**CTRL** Logic control input.

V<sub>INL</sub> Maximum input voltage for Logic 0.

V<sub>INH</sub> Minimum input voltage for Logic 1.

I<sub>IN</sub>L (I<sub>INH</sub>) Input current of the digital input.

C<sub>IN</sub> Digital input capacitance.

#### ton

Delay between applying the digital control input and the output switching on.

#### toff

Delay between applying the digital control input and the output switching off.

#### trise

Rise time. Time for the RF signal to rise from 10% to 90% of the on level.

#### t<sub>fall</sub>

Fall time. Time for the RF signal to fall from 90% to 10% of the on level.

#### **Off Isolation**

The attenuation between input and output ports of the switch when the switch control voltage is in the off condition.

#### Insertion Loss

The attenuation between input and output ports of the switch when the switch control voltage is in the on condition.

#### $\mathbf{P}_{-1 \, dB}$

1 dB compression point. The RF input power level at which the switch insertion loss increases by 1 dB over its low level value. It is a measure of how much power the on switch can handle before the insertion loss increases by 1 dB.

#### IP<sub>3</sub>

Third-order intermodulation intercept. This is a measure of the power in false tones that occur when closely spaced tones are passed through a switch, whereby the nonlinearity of the switch causes these false tones to be generated.

#### **Return Loss**

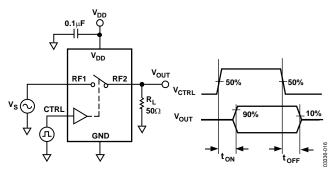
The amount of reflected power relative to the incident power at a port. Large return loss indicates good matching. By measuring return loss the VSWR can be calculated from conversion charts. voltage standing wave ratio (VSWR) indicates the degree of matching present at a switch RF port.

#### Video Feedthrough

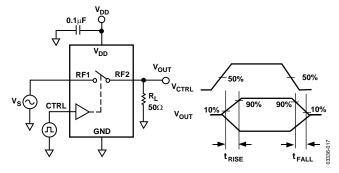
The spurious signals present at the RF ports of the switch when the control voltage is switched from high to low or low to high without an RF signal present.

### **TEST CIRCUITS**

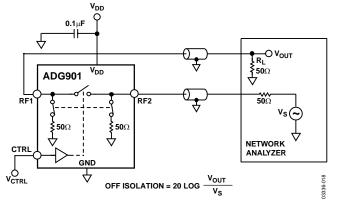
Similar setups for ADG902.













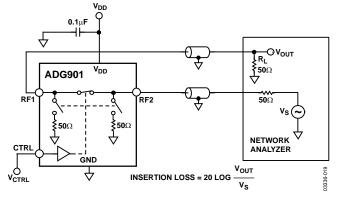


Figure 19. Insertion Loss

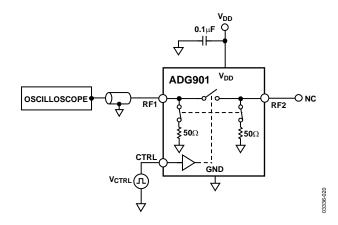


Figure 20. Video Feedthrough

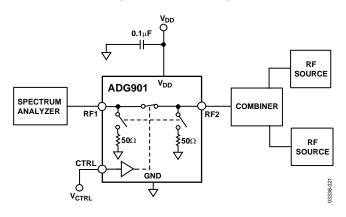


Figure 21. IP₃

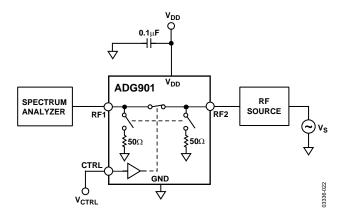


Figure 22. P<sub>-1 dB</sub>

### **APPLICATIONS**

The ADG901/ADG902 are ideal solutions for low power, high frequency applications. The low insertion loss, high isolation between ports, low distortion, and low current consumption of these parts make them excellent solutions for many high frequency switching applications.

Applications include switching between high frequency filters, ASK generators, and FSK generators.

#### **ABSORPTIVE vs. REFLECTIVE SWITCHES**

The ADG901 is an absorptive (matched) switch with 50  $\Omega$  terminated shunt legs and the ADG902 is a reflective switch with 0  $\Omega$  terminated shunts to ground. The ADG901 absorptive switch has a good VSWR on each port, regardless of the switch mode. An absorptive switch should be used when there is a need for a good VSWR that is looking into the port but not passing the through signal to the common port. The ADG901 is therefore ideal for applications that require minimum reflections back to the RF source. It also ensures that the maximum power is transferred to the load.

The ADG902 reflective switch is suitable for applications where high off port VSWR does not matter and the switch has some other desired performance feature. It can be used in many applications, including high speed filter selection. In most cases, an absorptive switch can be used instead of a reflective switch, but not vice versa.

### **ADG90x EVALUATION BOARD**

The ADG90x evaluation board allows designers to evaluate the high performance wideband switches with a minimum of effort. To prove that these devices meet user requirements, the user requires only a power supply and a network analyzer along with the evaluation board. An application note is available with the evaluation board and provides complete information on operating the evaluation board.

The RF1 port (see Figure 23) is connected through a 50  $\Omega$  transmission line to the top left SMA Connector J1. RF2 is connected through a 50  $\Omega$  transmission line to the top SMA Connector J2. J3 is connected to GND. A through transmission line connects J4 and J5 and this transmission line is used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a 4-layer, FR4 material with a dielectric constant of 4.3 and an overall thickness of 0.062 inches. Two ground layers with grounded planes provide ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.052 inches, clearance to ground plane of 0.030 inches, dielectric thickness of 0.029 inches, and a metal thickness of 0.014 inches.

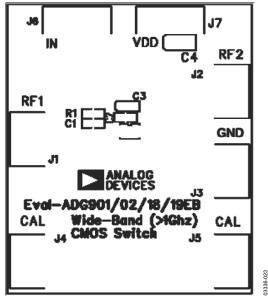
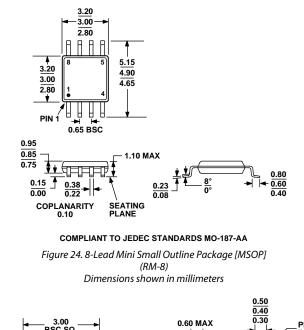
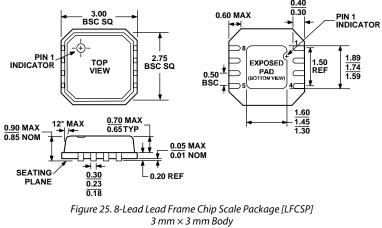


Figure 23. ADG90x Evaluation Board Top View

### **OUTLINE DIMENSIONS**





(CP-8-2) Dimensions shown in millimeters

### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
ADG901BRM	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B
ADG901BRM-500RL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B
ADG901BRM-REEL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B
ADG901BRMZ <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1T
ADG901BRMZ-REEL71	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1T
ADG901BCP-500RL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W6B
ADG901BCP-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W6B
ADG901BCPZ-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	S1T
ADG902BRM	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W7B
ADG902BRM-500RL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W7B
ADG902BRM-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	RM-8	W7B
ADG902BRMZ <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1V
ADG902BCP-500RL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W7B
ADG902BCP-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W7B
ADG902BCP-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	S1V
EVAL-ADG901EB		Evaluation Board		
EVAL-ADG902EB		Evaluation Board		

 $^{1}$  Z = Pb-free part.

### NOTES

### NOTES

### NOTES

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